

AM/FM/HD-Radio™ submicron technology automotive receiver



Features



- AEC-Q100 qualified
- · AM/FM reception with digital IF processing
- · Fully automotive grade CMOS design
- AM/FM Band
- · Low-IF, DSP-based architecture
- · Very high dynamic range built-in IF-ADC
- Minimum external component count
- Very small footprint package
- Multipath noise mitigation processing
- RDS demodulation with group and block synchronization
- Compatible with HD-Radio[™] and DRM
- · Digital Audio Output
- Fully RoHS-compliant

Description

The TDA7708 is a single chip fully-CMOS AM/FM tuner aimed at receivers for terrestrial radio broadcasting.

The TDA7708 is a complete integrated and optimized RF tuner for AM/FM reception. It allows the implementation of AM/FM solution (and also HD-Radio[™] with external STMicroelectronics's STA680 co-processor) for automotive grade receivers and other applications.

The TDA7708 combines state-of-art performance with minimum external component count, making it therefore ideal for integration into car radios and other radio devices with challenging performance, quality, reliability and, last but not least, cost requirements.

Such a low external component count is made possible by cutting-edge circuit and implementation techniques that overcome the major challenges affecting both very-low and zero IF receivers.

The TDA7708 features multiple front-end low-noise amplifiers (LNAs) to cover AM LW/MW/SW bands, and the entire FM band, with advanced automatic gain control (AGC) amplifier and mixer stages.

After on-chip IF filtering, the TDA7708 digitizes the signal with a very high dynamic range ADC; it processes the complex phase-quadrature baseband signal allowing applications like multipath noise mitigation, and integrated RDS decoding.

The TDA7708 furthermore integrates the HD-Radio[™] channel filtering.

Besides providing optimal AM/FM quality reception, the TDA7708 makes it the ideal solution to realize a complete HD-Radio $^{\text{TM}}$ receiver solution (in combination with the external STA680 HD-Radio $^{\text{TM}}$ decoder) or a DRM receiver (paired to the STA660DRM), with a low bill of material, high performance and real automotive grade quality and reliability.

Product status

Device summary				
Order code	Package	Packing		
TDA7708		Trov		
TDA7708CB	VFQFPN64	Tray		
TDA7708TR	(9 x 9 x 1 mm)	Tape &		
TDA7708CBTR	ŕ	Reel		



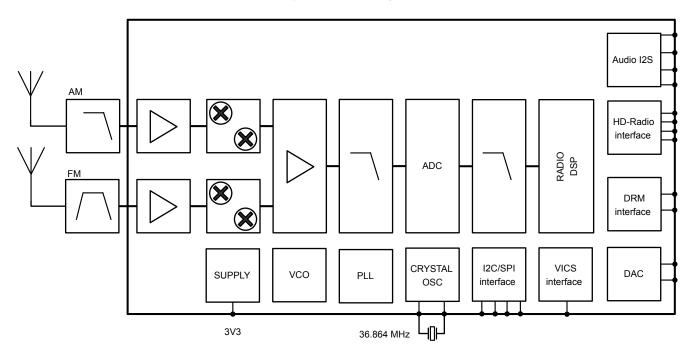
The TDA7708CB requires a very small FW code to be downloaded for booting the IC, thus making it especially suited to systems whose microcontroller has limited code storage capability.

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1 Block diagram

Figure 1. Block diagram



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2 Electrical specification

2.1 Absolute maximum ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Test condition	Min	Тур	Max	Units
V_{CC}	Abs. supply voltage	-	-0.5	-	3.6	V
T _{stg}	Storage temperature	-	-55	-	150	°C
		Human Body model	> ±2000 ⁽¹⁾			
V_{ESD}	V _{ESD} ESD absolute minimum withstand voltage	Charged device model	> ±500 ⁽²⁾		V	
		Charged device model, corner pins	> ±750			
_	Max. input current at any pin	lunax	±100		mA	
-	(latch-up characteristic)	INMAX		1100		

- 1. |±1000| on AM_IN pin
- 2. |±400| on AM_IN pin

2.2 Thermal data

Table 2. Thermal data

Symbol	Parameter	Test condition	Value	Units
R _{th j-amb}	Thermal resistance junction-to-ambient	Multilayer 2s2p as per JEDEC JESD51-7	27	°C/W

2.3 General key parameters

Table 3. General key parameters

Symbol	Parameter	Test condition	Min	Тур	Max	Units
V _{CC}	3.3 V supply voltage	-	3.15	3.3	3.45	V
I _{CC}	Supply current	FM @108 MHz, active interfaces (10 pF load)	-	-	350	mA
T _{amb}	Ambient temperature range	-	-40	-	85	°C
T _{j_oper}	Operative junction temp	-	-	-	125	°C
P _{diss}	Dissipated power	R _{ext} = 12 Ohm	-	-	1	W

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3 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

3.1 VFQFPN-64 (9x9x1.0mm) package information

Figure 2. VFQFPN-64 (9x9x1.0 mm) package outline

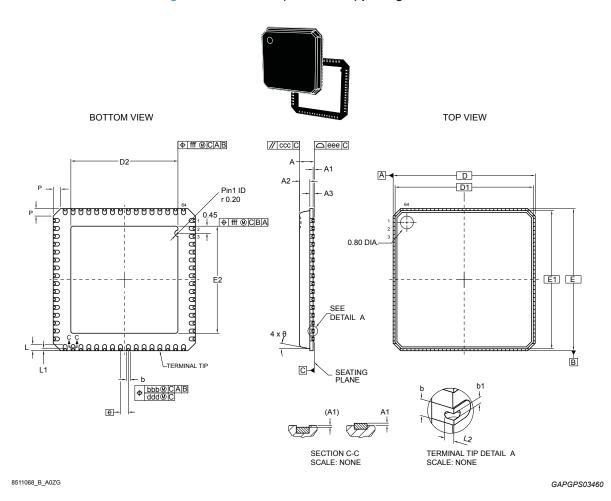


Table 4. VFQFPN-64 (9x9x1.0 mm) package mechanical data

Ref.	Dimensions in mm				
Nei.	Min.	Тур.	Max.		
Θ	-	-	14		
Α	-	-	1.0		
A1	0.00	-	0.05		
A2	0.55	-	0.80		
A3		0.20 REF			
b ⁽¹⁾	0.18	0.25	0.30		

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Ref.		Dimensions in mm			
Kei.	Min.	Тур.	Max.		
b1	-	0.15	-		
D		9.00 BSC			
D1 ⁽²⁾		8.75 BSC			
D2	-	6.70	-		
е		0.50 BSC			
E		9.00 BSC			
E1 ⁽²⁾		8.75 BSC			
E2	-	6.70	-		
L	0.30	-	0.50		
L1		0.15 REF			
L2	-	0.10	-		
Р	-	-	0.60		
Tolerance of form and position	n				
aaa		0.15			
bbb		0.10			
ccc	0.10				
ddd		0.05			
eee		0.08			
fff		0.10			

^{1.} Maximum allowable burr is 0.076 mm in all directions.

Note:

The package is compliant to IPC/JEDEC J-STD-020D June 2007 standard Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices, MSL Level 3.

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^{2.} D1 and E1 are Maximum plastic body size dimensions including mold mismatch. Dimensions D1 and E1 do not include mold flash or protrusions. Allowable mold flash or protrusions is "0.25 mm (0.0098 inch)" per side.



Revision history

Table 5. Document revision history

Date	Revision	Changes	
16-Dec-2014	1	Initial release.	
29-Nov-2016	2	Fully revised.	
15-May-2017	3	Added 'RDS demodulation' on Section Features.	
25-Jan-2018	4	Updated Section Description and Device summary table on cover page.	
25-Nov-2019	5	Updated Figure 1. Block diagram.	

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